

20 V, 0.5 A low VF MEGA Schottky barrier rectifier 4 August 2015 Produ

Product data sheet

## 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small SOD882D (DFN1006D-2) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

## 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 0.5 A
- Reverse voltage: V<sub>R</sub> ≤ 20 V
- Low forward voltage  $V_F \leq 390 \text{ mV}$
- AEC-Q101 qualified
- Ultra small and leadless SMD plastic package
- Solderable side pads
- Package height typ. 0.37 mm

## 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications
- Ultra high-speed switching
- LED backlight for mobile application

## 4. Quick reference data

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Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub> average forward current	•	δ = 0.5 ; f = 20 kHz; T <sub>sp</sub> ≤ 140 °C; square wave		-	-	0.5	A
		δ = 0.5 ; f = 20 kHz; T <sub>amb</sub> ≤ 115 °C; square wave	[1]	-	-	0.5	A
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	20	V
V <sub>F</sub>	forward voltage	$I_F$ = 500 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02 ; $T_j$ = 25 °C		-	353	390	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C		-	28	50	μA

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[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode[1]		1 🛃 2
2	А	anode		sym001
			Transparent top view	
			DFN1006D-2 (SOD882D)	

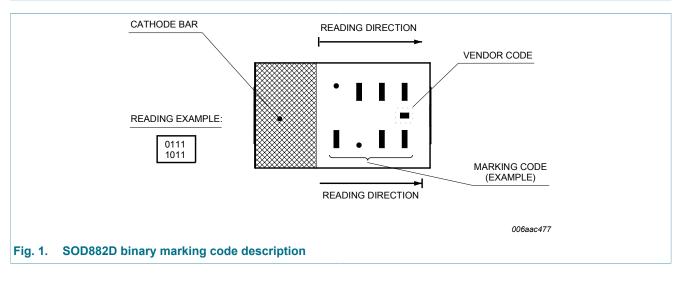
[1] The marking bar indicates the cathode.

## 6. Ordering information

Table 3.       Ordering information						
Type number	Package					
	Name	Description	Version			
PMEG2005BELD	DFN1006D-2	DFN1006D-2: leadless ultra small plastic package; 2 terminals	SOD882D			

## 7. Marking

Table 4. Marking codes	
Type number	Marking code
PMEG2005BELD	0010 1000



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#### 20 V, 0.5 A low VF MEGA Schottky barrier rectifier

#### **Limiting values** 8.

#### Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	20	V
l <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 140 °C		-	0.5	А
I <sub>F(AV)</sub>	average forward current	δ = 0.5 ; f = 20 kHz; T <sub>sp</sub> ≤ 140 °C; square wave		-	0.5	A
		δ = 0.5 ; f = 20 kHz; T <sub>amb</sub> ≤ 115 °C; square wave	[1]	-	0.5	A
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ ms}; \delta \le 0.25$		-	3	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	6	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[ <u>2][3]</u>	-	370	mW
			[1][3]	-	735	mW
			[4][3]	-	1135	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. [2]

Reflow soldering is the only recommended soldering method. Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

[3] [4]

#### 20 V, 0.5 A low VF MEGA Schottky barrier rectifier

## 9. Thermal characteristics

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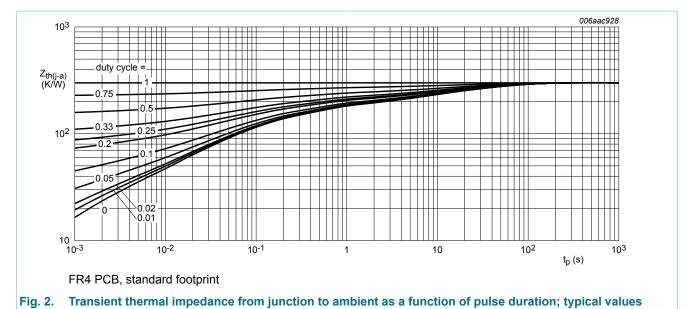
Table 6. Thermal characteristics								
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
R <sub>th(j-a)</sub> thermal resistance from junction to ambient		in free air	[1][2][3]	-	-	340	K/W	
		[1][4][3]	-	-	170	K/W		
			[1][5][3]	-	-	110	K/W	
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[6]	-	-	25	K/W	

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

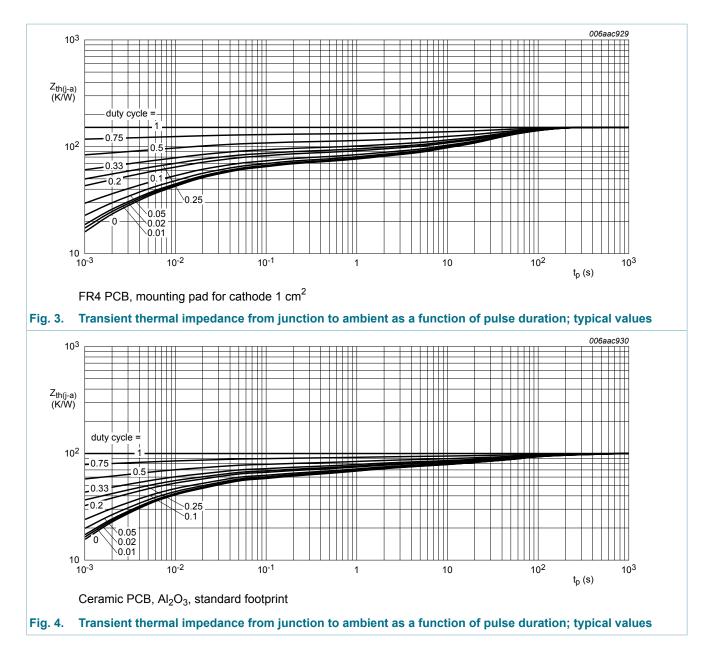
- <sup>[4]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [6] Soldering point of cathode tab.



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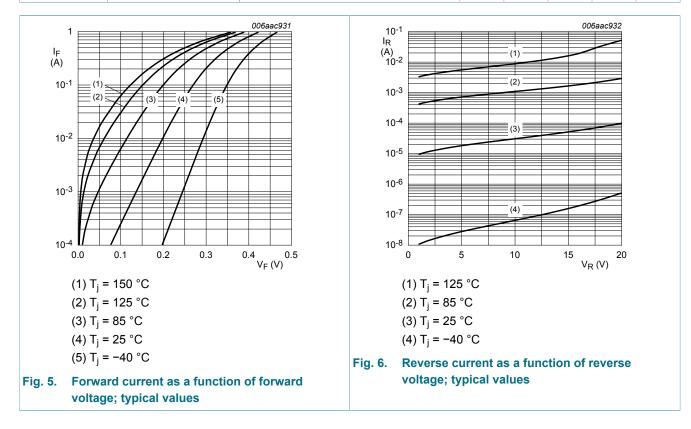


## **10. Characteristics**

Table 7.   Characteristics								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V <sub>F</sub> forward voltage	$I_F$ = 0.1 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02 ; T <sub>j</sub> = 25 °C		-	79	105	mV		
		$I_{\text{F}} = 1 \text{ mA; pulsed; } t_{\text{p}} \le 300  \mu\text{s;} \qquad \qquad - \\ \bar{\delta} \le 0.02 \text{ ; } T_{\text{j}} = 25 ^{\circ}\text{C}$	-	137	170	mV		
		I <sub>F</sub> = 10 mA; pulsed; t <sub>p</sub> ≤ 300 μs; $\delta \le 0.02$ ; T <sub>j</sub> = 25 °C		-	197	235	mV	

#### 20 V, 0.5 A low VF MEGA Schottky barrier rectifier

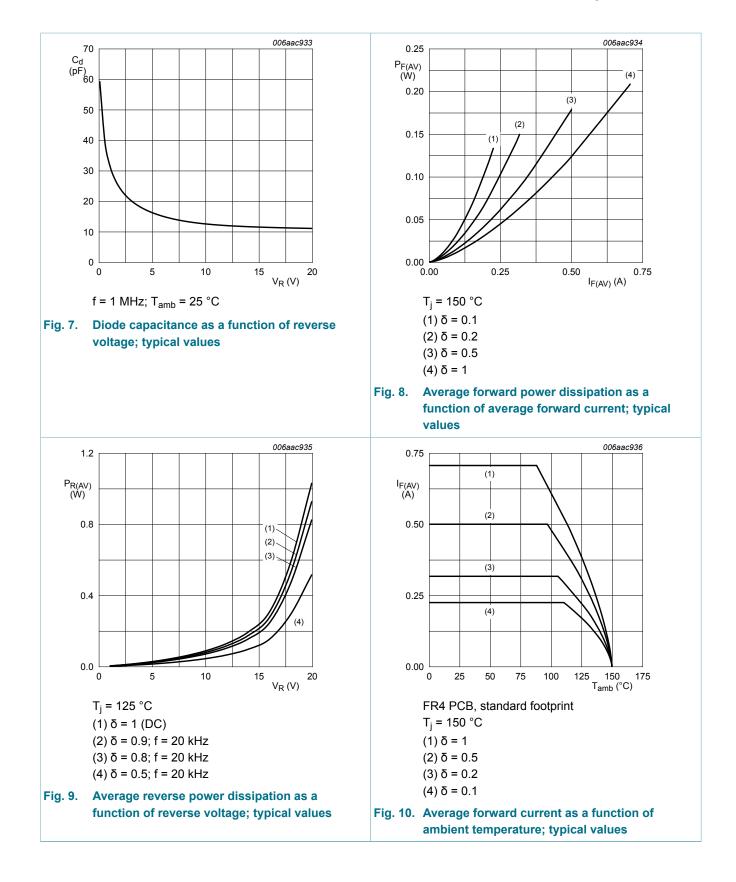
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
		$I_F$ = 100 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02 ; $T_j$ = 25 °C	-	266	310	mV
		$I_F$ = 500 mA; pulsed; $t_p \le 300 \ \mu$ s; δ ≤ 0.02 ; T <sub>j</sub> = 25 °C	-	353	390	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-	28	50	μA
	V <sub>R</sub> = 20 V; T <sub>j</sub> = 25 °C	-	87	200	μA	
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	31	40	pF
t <sub>rr</sub>	reverse recovery time	$I_{\rm F} = 0.5 \text{ A}; I_{\rm R} = 0.5 \text{ A}; I_{\rm R(meas)} = 0.1 \text{ A}; T_{\rm j} = 25 \ ^{\circ}\text{C}$	-	1.6	-	ns
V <sub>FRM</sub>	peak forward recovery voltage	I <sub>F</sub> = 0.5 A; dI <sub>F</sub> /dt = 20 A/µs; T <sub>j</sub> = 25 °C	-	565	-	mV



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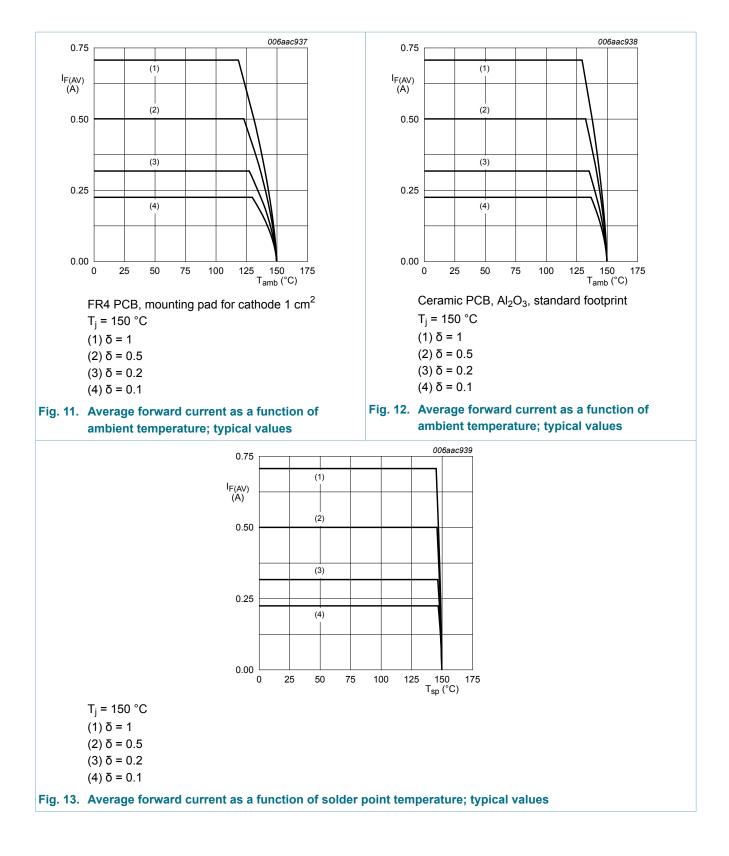
#### 20 V, 0.5 A low VF MEGA Schottky barrier rectifier



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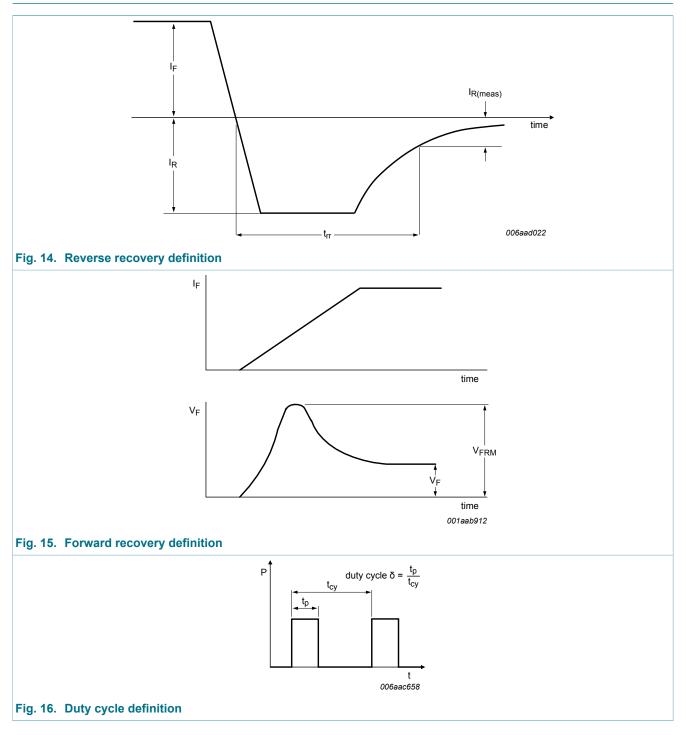
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#### 20 V, 0.5 A low VF MEGA Schottky barrier rectifier



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## **11. Test information**



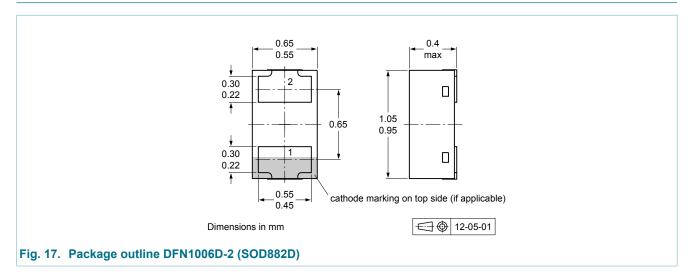
The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

#### 20 V, 0.5 A low VF MEGA Schottky barrier rectifier

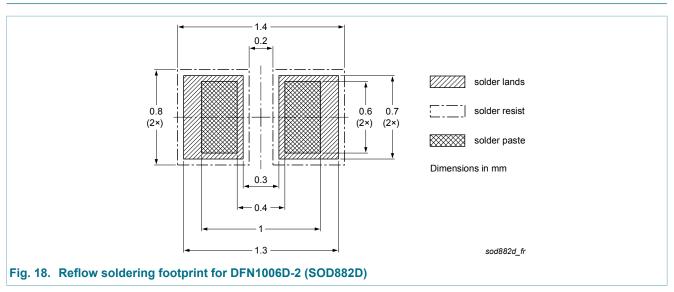
#### **11.1 Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



## 13. Soldering



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# 14. Revision history

Table 8. Revision history							
Document ID	Release date	Document status	Change notice	Supersedes			
PMEG2005BELD v.4	20150804	Product data sheet	-	PMEG2005BELD v.3			
Modifications:	Section "Marking":	updated Figure 1.					
PMEG2005BELD v.3	20120704	Product data sheet	-	PMEG2005BELD v.2			
PMEG2005BELD v.2	20120312	Product data sheet	-	PMEG2005BELD v.1			
PMEG2005BELD v.1	20120111	Preliminary data sheet	-	-			

#### 20 V, 0.5 A low VF MEGA Schottky barrier rectifier

## **15. Legal information**

#### 15.1 Data sheet status

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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